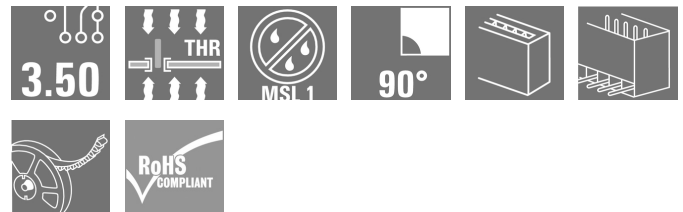


**SL-SMT 3.50/12/90G 3.2SN BK RL****Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

[www.weidmueller.com](http://www.weidmueller.com)**Product image**

**High-temperature-resistant male header, 3.50 mm pitch.**

- **Plugging direction parallel (90°), straight 180° or angled (135°) to PCB**
- **Housing variants: closed side (G), screw flange (F), solder flange (LF) or snap-on solder flange (RF)**
- **Optimised for the SMT process**
- **Pin length 3.2 mm universal for all soldering methods**
- **Pin length 1.5 mm optimised for reflow soldering methods**
- **Packed either in a box (BX) or tape-on-reel (RL)**
- **Male header can be coded**

**General ordering data**

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number of poles: 12, 90°, Solder pin length (l): 3.2 mm, tinned, black, Tape
Order No.	<a href="#">1490230000</a>
Type	SL-SMT 3.50/12/90G 3.2SN BK RL
GTIN (EAN)	4050118300000
Qty.	385 pc(s).
Product data	IEC: 320 V / 15 A UL: 300 V / 10 A
Packaging	Tape

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**Technical data****Dimensions and weights**

Depth	11.1 mm	Depth (inches)	0.437 inch
Height	10.7 mm	Height (inches)	0.421 inch
Height of lowest version	7.5 mm	Width	43.4 mm
Width (inches)	1.709 inch	Net weight	3.13 g

**System specifications**

Product family	OMNIMATE Signal - series BL/SL 3.50	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 "	Outgoing elbow	90°
Number of poles	12	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0.03 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter tolerance (D)+	0.1 mm
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	38.5 mm	L1 in inches	1.516 "
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE 57 106	finger-safe plugged/ back-of-hand-safe unplugged	Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	6 N	Pulling force/pole, max.	6 N

**Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIla
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	tinned	Layer structure of solder connection	2...3 µm Ni / 5...7 µm Sn
Layer structure of plug contact	2...3 µm Ni / 5...7 µm Sn	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

**Rated data acc. to IEC**

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	15 A
Rated current, max. number of poles (Tu=20°C)	12 A	Rated current, min. number of poles (Tu=40°C)	13 A
Rated current, max. number of poles (Tu=40°C)	10 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 100 A

**Rated data acc. to CSA**

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A

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**Technical data****Rated data acc. to UL 1059**

Institute (UR)



Certificate No. (UR)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group B / UL 1059) 10 A

Rated current (Use group D / UL 1059) 10 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

**Packing**

ESD Level packaging static dissipative

VPE length 330 mm

VPE height 60 mm

Tape width (W) 56 mm

Tape pocket height (A0) 11.41 mm

Tape pocket separation (P1) 16 mm

Tape pocket separation (F) 26.2 mm

Surface resistance  $R_s = 10^9 - 10^{12} \Omega$ 

Packaging Tape

VPE width 330 mm

Tape depth (T2) 12.1 mm

Tape pocket depth (K0) 11.6 mm

Tape pocket width (B0) 43.7 mm

Tape hole separation (E) 1.75 mm

Tape reel diameter  $\varnothing$  (A) 330 mm**Classifications**

ETIM 6.0 EC002637

ETIM 7.0 EC002637

ETIM 8.0 EC002637

ETIM 9.0 EC002637

ECLASS 9.0 27-44-04-02

ECLASS 9.1 27-44-04-02

ECLASS 10.0 27-44-04-02

ECLASS 11.0 27-46-02-01

ECLASS 12.0 27-46-02-01

ECLASS 13.0 27-46-02-01

**Important note**

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Gold-plated contact surfaces on request
- Rated current related to rated cross-section & min. No. of poles.
- Diameter of solder eyelet  $D = 1.4 + 0.1 \text{ mm}$
- Solder eyelet diameter  $D = 1.5 + 0.1 \text{ mm}$ , from 9 poles
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load
- Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

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[www.weidmueller.com](http://www.weidmueller.com)**Technical data****Approvals**

Approvals



ROHS	Conform
UL File Number Search	UL Website
Certificate No. (UR)	E60693

**Downloads**

Approval/Certificate/Document of Conformity

[Declaration of the Manufacturer](#)

Engineering Data

[CAD data – STEP](#)

Product Change Notification

[PCN\\_2015\\_208\\_PL30X\\_SC-SMT\\_SL\\_SMT\\_3.xx\\_5.xx\\_neue\\_Tapeverpackung\\_Step\\_3\\_DE](#)  
[PCN\\_2015\\_208\\_PL30X\\_SC-SMT\\_SL\\_SMT\\_3.xx\\_5.xx\\_new\\_Tape\\_Packaging\\_Step\\_3\\_EN](#)  
[Changeover to ESD bags for "Tape on Reel" products](#)  
[Umstellung auf ESD-Beutel bei „Tape on Reel“ Produkten](#)

Catalogues

[Catalogues in PDF-format](#)

Brochures

[FL DRIVES EN](#)  
[MB SMT EN](#)  
[FL DRIVES DE](#)  
[MB DEVICE MANUF. EN](#)  
[FL BUILDING SAFETY EN](#)  
[FL APPL LED LIGHTING EN](#)  
[FL INDUSTR.CONTROLS EN](#)  
[FL MACHINE SAFETY EN](#)  
[FL HEATING ELECTR EN](#)  
[FL APPL INVERTER EN](#)  
[FL\\_BASE\\_STATION\\_EN](#)  
[FL ELEVATOR EN](#)  
[FL POWER SUPPLY EN](#)  
[FL 72H SAMPLE SER EN](#)  
[PO OMNIMATE EN](#)

White paper surface mount technology

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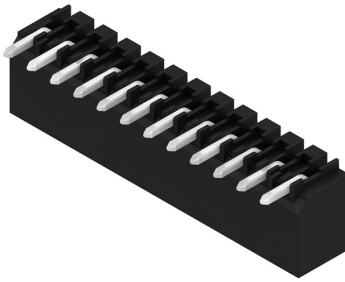
## SL-SMT 3.50/12/90G 3.2SN BK RL

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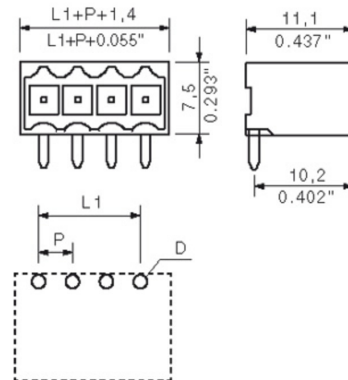
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# Drawings

## Product image

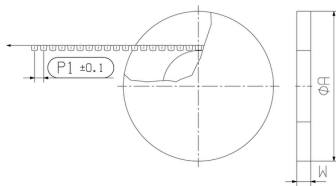


## Dimensional drawing

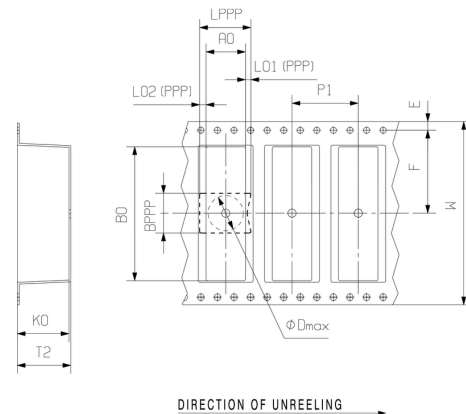


$L1 = 38.50 \text{ mm} \mid P = 3.50 \text{ mm}$

## Dimensional drawing



## Dimensional drawing



## Example of use



## Recommended wave soldering profiles

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Fax: +49 5231 14-292083  
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### Single Wave:



### Double Wave:



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

## Recommended reflow soldering profile

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## Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3\text{K/s}$ . In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq -6\text{K/s}$  solder is cured. Board and components cool down while avoiding cold cracks.